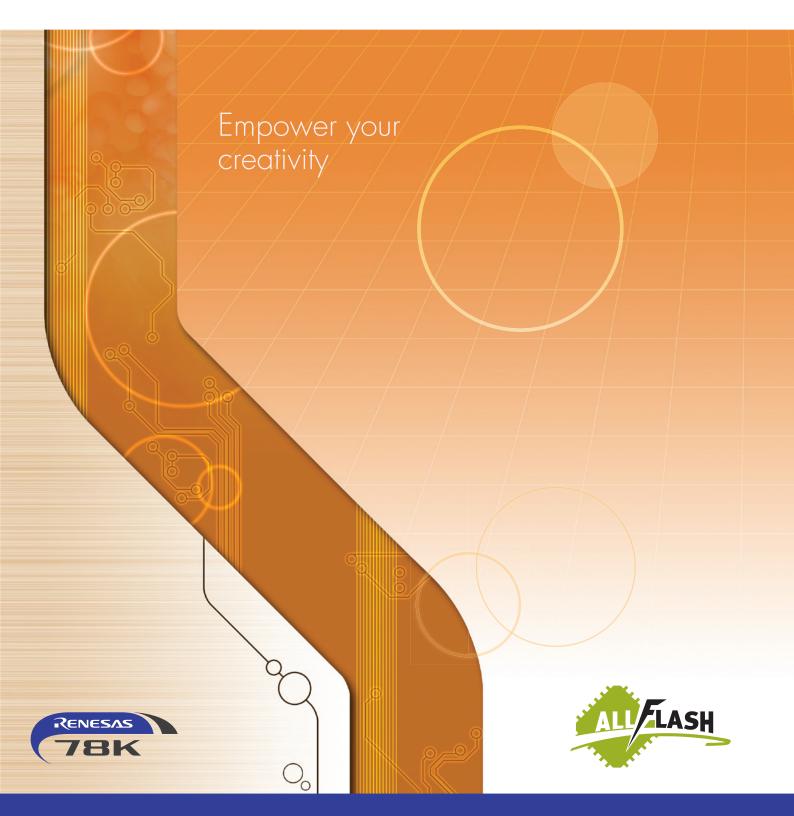


Renesas Microcomputer

16-bit All Flash

78K0R Microcontrollers





Shifting to "All Flash"

All of our new 16-bit general-purpose microcontrollers incorporate flash memories.

All Flash Continues to Evolve. Contributing to the Success of Customers

The "Shifting to All Flash" concept involves switching to flash memory products for the entire lineup of microcontrollers offered by Renesas Electronics.

This lineup comprises the V850E and V850ES 32-bit microcontrollers delivering high performance for system control, and the 78K0 and 78K0S 8-bit microcontrollers, which boast a small size and low power consumption making them ideal as subcontrollers.

Renesas Electronics' All Flash lineup is completed by the 78K0R 16-bit microcontrollers, positioned between 8-bit and 32-bit microcontrollers.

These microcontrollers achieve a low power consumption on a par with that of 8-bit microcontrollers while delivering the performance of 16-bit microcontrollers.

Renesas Electronics' All Flash lineup supports from 30 to 144 pins and ROM capacities of 16 to 512 KB. The lineup also inherits the existing 78K0 and 78K0S 8-bit microcontrollers. Should 8-bit microcontrollers fall short in terms of performance and ROM capacity for the intended application, smooth migration to 16-bit microcontrollers is possible.

Renesas Electronics also offers an infrastructure that enables more effective and simple use of All Flash. Our products and environment, which make the most of the merits of flash memory products, work for the success of our customers everywhere.

Road Map

a

78K0R/Kx3 Wide-voltage operation support 144-pin **78K0R/KJ3** 128-pin **78K0R/KH3** 78K0R/KG3

64-pin **78K0R/KE3**

78K0R/Kx3-L

Low-power and wide-voltage operation support 100-pin 78K0R/KG3-L 80-pin **78K0R/KF3-L** 64-pin 78K0R/KE3-L 52-pin **78K0R/KD3-L** 40/44/48-pin **78K0R/KC3-L**

78K0R/KF3

78K0R/lx3

Inverter control support 78K0R/IE3 64-pin 52-pin **78K0R/ID3** 38/44/48-pin **78K0R/IC3** 30-pin **78K0R/IB3**

Low-power, digital home electronics communication

Analog enhancement, low power, wide-voltage

78K0R/Kx3-L (USB)

Low-power, USB support

100-pin 78K0R/KG3-C

80-pin **78K0R/KF3-C**)

64-pin **78K0R/KE3-A**

64-pin **78K0R/KE3-L**

48-pin **78K0R/KC3-L**

78K0R/Kx3-C

78K0R/Kx3-A

operation support

78K0R/Lx3

LCD controller/drivers, analog enhancement, low power 128-pin **78K0R/LH3** 78K0R/LG3 78K0R/LF3

μ**PD78F8043**

IO-Link support

56-pin μ**PD78F8043**

μPD78F8058

RF remote control support

56-pin μ**PD78F8058**

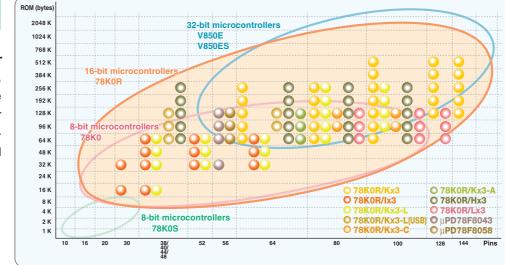
78K0R/Hx3

CAN support, analog enhancement 100-pin **78K0R/HG3**

> 80-pin **78K0R/HF3** 78K0R/HE3

48-pin **78K0R/HC3**

All Flash product lineup



- Expanded from 8 bits to 32 bits -The 78K0R 16-bit microcontrollers. positioned at the high end of the 78K microcontrollers, support your systems by giving them higher performance and more sophisticated functions.

Application examples

All Flash microcontrollers are suitable for various systems using an 8- or 16-bit microcontroller and raise the commercial value of customer systems.



Cameras

Digital still cameras, digital video cameras.



Audio Portable audio. component stereo systems,

home theater systems



Computer peripherals

inkjet printers, scanners fax machines



Video and recording equipment Blu-ray players, Blu-ray recorders industrial cameras



Other

Healthcare equipment Body fat scales, blood pressure monitors

Portable devices Home appliances Air conditioners. IC recorders refrigerators, washing machines, microwave ovens



Electronic instruments. electric bidets, toys, remote controllers, etc.



Industrial equipment Industrial motors control equipment, vending machines, power meters

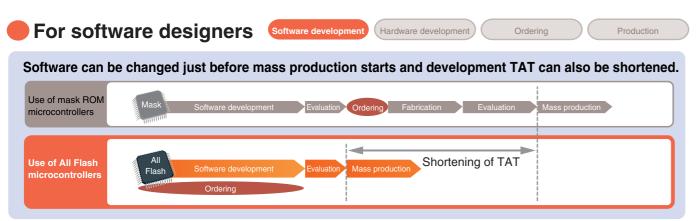
Flash microcontrollers can boost the competitiveness of your systems. Based on this concept, we are shifting to "All Flash".



Flash microcontrollers offer overwhelming advantages.

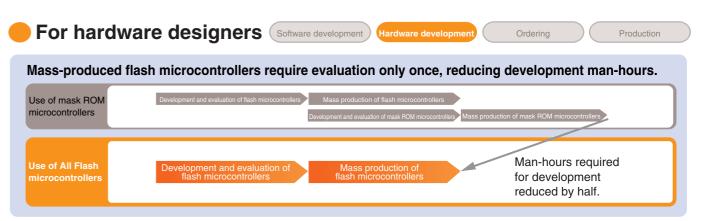
Compared to mask ROM microcontrollers, flash microcontrollers definitely contribute to speeding up system development. Microcontrollers can be ordered before program completion and programs can be written even after the microcontroller has been mounted on the board. Microcontroller order placement and program development can therefore be done concurrently, allowing TAT to be shortened as a result.

In addition, when flash microcontrollers are used for products with many different versions or that are localized for specific regions, the cost of ordering mask ROM microcontrollers is eliminated and purchase and stock management costs can be slashed.



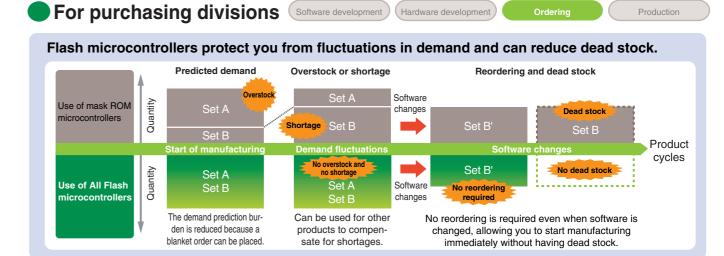
Since mask ROM microcontrollers cannot be ordered until their specifications are finalized, last-minute software changes can be problematic

On the other hand, specifications for flash microcontrollers can be changed just prior to the start of mass production. Thus orders for flash microcontrollers can be placed while the software is still being developed, allowing the development TAT to be shortened.

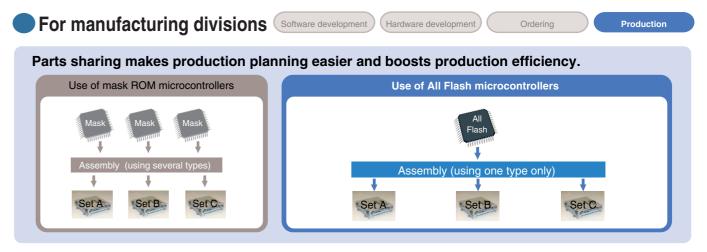


In the case of mass-produced mask ROM microcontrollers, evaluations of both flash microcontrollers and mask ROM microcontrollers are required.

Since evaluated flash microcontrollers can be directly mass-produced, the man-hours required for development are reduced by half, resulting in greatly shortened development TAT.



Mass-produced mask ROM microcontrollers may become dead stock as the result of changes in software or fluctuations in demand. On the other hand, flash microcontrollers can be mass-produced immediately after software changes and used for other products, resulting in fewer lost opportunities, less dead stock, and lower ordering costs.



In the case of mass-produced mask ROM microcontrollers, the use of different software for different products necessitates the use of a different microcontroller for each type of product. In contrast, mass-produced flash microcontrollers facilitate the sharing of parts since they can be used for various products by simply rewriting the software.

16 - bit All Flash 2010.12

Have you ever had to give up something when upgrading a system? With Renesas Electronics, you don't have to compromise.



16-bit All Flash microcontrollers that do not compromise

crocontrollers has become widespread to support ever increasing system performance and fast development TAT. However, the use of high performance microcontrollers and flash microcontrollers often imposes compromises,

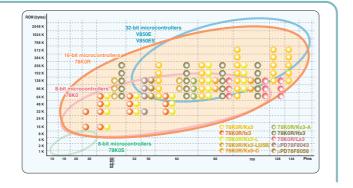
The use of high-performance microcontrollers and flash mi- in terms of higher power consumption and the compatibility of existing software resources.

> Renesas Electronics' 78K0R 16-bit microcontroller realizes 16-bit performance with All Flash without such compromi-

Large selection

We offer 202 products!

To respond to demands for various types of microcontrollers, we offer a range of 202 All Flash 16-bit microcontrollers. Among these are the 78KOR/Kx3, which features a large-capacity memory, the 78K0R/Kx3-L, which has a low standby current, the 78K0R/Kx3-A with a built-in high-performance 12-bit A/D converter and the 78KOR/Lx3 with a built-in LCD driver, and the 78KOR/Hx3, which has a fast operating speed of 24 MHz. Our 16-bit All Flash microcontrollers are available in either a 40-pin 6 x 6 mm WQFN or a 48-pin 7 x 7 mm WQFN. These packages are 46% thinner and 75% smaller than our conventional 16-bit microcontroller package (which is a 100-pin LQFP with a size of 14 mm x 14 mm), helping you reduce the size of your set. With this extensive lineup, you can choose the optimal product.



Low cost

Reducing the total cost!

The 78K0R 16-bit microcontrollers are provided with features such as flash memory instead of EEPROM, an oscillator, a voltage detector, and a power-on reset function. The number of components used and the system costs can be reduced in contrast to products not provided with these features. Also, costs can be further reduced because the 78K0R/Kx3-A and 78K0R/Lx3 include an operational amplifier, and the 78KOR/KC3-L, 78KOR/KD3-L, 78KOR/KE3-L, and 78KOR/Ix3 include a programmable gain amplifier and a comparator.

■ Total cost reduction through embedded peripheral IC functions

Low power consumption

Go fast. Stay cool. **Combining high performance** with low power consumption!

Through the use of a 16-bit design, Renesas Electronics has achieved 3-stage pipeline architecture CPUs that boast a performance of 30.5MIPS at 24 MHzNote 1 These microcontrollers save energy thanks to their supply current, which is low compared to the 16-bit products of other companies.

They also feature a calendar function (RTC) that automatically updates the time and date until 2099 without the need to boot the CPU, helping extend battery life in systems that require a watch counter.

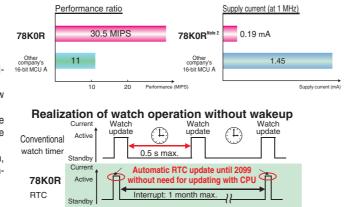
Current users of 16-bit microcontrollers can achieve lower power consumption, while 8-bit microcontroller users can enjoy higher performance without an increase in power consumption.

Notes 1. Dhrystone 2.1

2. When using the 78K0R/KC3-L, 78K0R/KD3-L, 78K0R/KE3-L, 78K0R/Lx3, or 78K0R/Kx3-A

Notes 1. 78K0R/Kx3-A and 78K0R/Lx3 only 2. 78K0R/KC3-L, 78K0R/KD3-L, 78K0R/KE3-L, and 78K0R/lx3 only

■ Saving energy with high performance of 16-bit design



Wide variety of products for specific applications

We offer ideal products for various applications!

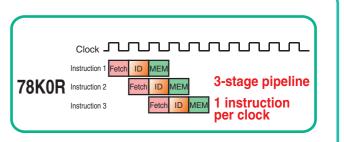
Renesas Electronics offers a wide range of products for specific applications, such as the 78K0R/Kx3-C provided with a feature for linking digital AV devices, the 78K0R/lx3 with a multifunction timer capable of precision inverter control, the µPD78F8043 with an on-chip IO-Link transceiver that facilitates communication in industrial systems, and the µPD78F8058 which enables communication with RF remote controllers. In addition to the basic features, the specialized features of the products are well developed, enabling you to choose the best product for your application.



High performance and functionality

Includes high-performance CPU and sophisticated peripheral functions!

The 78K0R microcontrollers execute most instruction processing in one clock via three-stage pipeline control. 32-bit (16 bits × 16 bits) calculations can also be performed thanks to the on-chip multiplier/divider. Furthermore, a sophisticated timer function can be realized by interlocking the operation of multiple-channel timers. The 78K0R/lx3 enables A/D conversion in synchronization with 3 phase sine-wave PWM output and timers.



High reliability

Our products incorporate our experience and technology in the automotive field as well as software protection functions!

All our products incorporate the experience we have gained in the process of supplying microcontrollers for over 1,000 types of applications and the technology we developed for flash microcontrollers for the automotive field. Our products also feature functions that disable reading and malicious software rewriting and erasing, thus offering maximum protection of your valuable software.

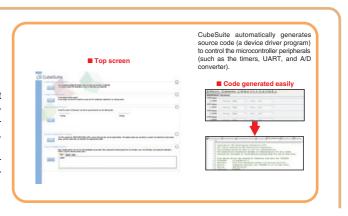


Rich development environment

We offer inexpensive, easy-to-use, and convenient tools!

Renesas Electronics provides an easy-to-use and convenient development environment, exemplified by our newly released CubeSuite™ integrated development platform. CubeSuite can be used to compile and debug programs, manage pin layouts, generate code for microcontroller peripherals, and execute high-speed building.

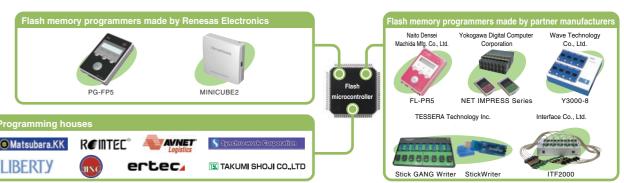
Add MINICUBE2, an on-chip debug emulator with flash memory programming capability, into the mix and you have a powerful environment that enables fast and accurate system development.



Support for mass production

In addition to a large lineup of programming tools, we also offer programming services!

Renesas Electronics and partner manufacturers offer a large number of programming tools, making programming possible in many different settings such as development environments and production lines. Moreover, programming services are also available from partner manufacturers both in Japan and overseas, serving a broad range of needs such as large-volume programming after shipping.



Large selection (1/2)

We offer flash microcontrollers in various packages and ROM or RAM sizes, allowing you to select the best flash microcontroller for your product or application.

Commercial Name	78K0R	/KC3-L	78K0R/KD3-L	78K0R/KE3-L	78K0R/KF3-L	78K0R/KG3-L	78K0R/KC3-L	78K0R/KE3-L	78K0R/KE3-A	78K0R/KE3	78K0R/KF3	78K0R/KG3	78K0R/KH3	78K0R/KJ
Pin Count ROM (bytes)	40/44-pin	48-pin	52-pin	64-pin	80-pin	100-pin	48-pin	64-pin	64-pin	64-pin	80-pin	100-pin	128-pin	144-pin
512 K	Product name (RAM (bytes))									78K0R/I	(x3	μ PD78F1168A (30 K*¹)	μ PD78F1178A (30 K*¹)	μ PD78F1188 (30 K*¹)
384 K										Microconti	ollers	μ PD78F1167A (24 K)	μ PD78F1177A (24 K)	μ PD78F118 (24 K)
256 K					μ PD78F1028* ² (12 K* ³)	μ PD78F1030* ² (12 K* ³)			12-bit A/D Converter	μ PD78F1146A (12 K*⁴)	μ PD78F1156A (12 K*⁴)	μ PD78F1166A (12 K* ⁴)	μ PD78F1176A (12 K)	μ PD78F118 (12 K)
192 K	78K0F	R/Kx3-L	Microc	ontrollers	μPD78F1027*² (10 K)	μPD78F1029*² (10 K)		3-L (USB) ntrollers	78K0R/Kx3-A Microcontrollers	μ PD78F1145A (10 K)	μ PD78F1155A (10 K)	μ PD78F1165A (10 K)	μ PD78F1175A (10 K)	μ PD78F118 (10 K)
128 K					μ PD78F1012 (8 K* ⁵)	μPD78F1014 (8 K* ⁵)	μ PD78F1024 (8 K* ⁵)	μPD78F1026 (8 K* ⁵)	μ PD78F1018 (7 K)	μ PD78F1144A (8 K)	μ PD78F1154A (8 K)	μ PD78F1164A (8 K)	μ PD78F1174A (8 K)	μ PD78F11 8 (8 K)
96 K					μ PD78F1011 (6 K)	μ PD78F1013 (6 K)	μ PD78F1023 (8 K* ⁵)	μ PD78F1025 (8 K*⁵)	μ PD78F1017 (6 K)	μ PD78F1143A (6 K)	μ PD78F1153A (6 K)	μ PD78F1163A (6 K)		
64 K	μ PD78F1003 (3 K*°)	μ PD78F1003 (3 K*°)	μ PD78F1006 (3 K* ⁶)	μ PD78F1009 (3 Κ* ⁶)	μ PD78F1010 (4 K)		μ PD78F1022 (6 K)		μ PD78F1016 (4 K)	μ PD78F1142A (4 K)	μ PD78F1152A (4 K)	μ PD78F1162A (4 K)		
48 K	μ PD78F1002 (2 K)	μ PD78F1002 (2 K)	μPD78F1005 (2 K)	μ PD78F1008 (2 K)										
32 K	μ PD78F1001 (1.5 K)	μ PD78F1001 (1.5 K)	μ PD78F1004 (1.5 K)	μPD78F1007 (1.5 K)										
16 K	μ PD78F1000 (1 K)													
Package	44-pin LQFP (GB) Thickness: 1.4 mm 10 × 10 mm Pitch: 0.8 mm 40-pin WQFN'2 (K8) Thickness: 0.75 mm 6 × 6 mm Pitch: 0.5 mm		52-pin LQFP (GB) Thickness: 1.4 mm 10 × 10 mm Pitch: 0.65 mm	64-pin TQFP (GA) Thickness: 1.4 mm 12 × 12 mm Pitch: 0.65 mm 64-pin TQFP (GA) Thickness: 1.0 mm 7 × 7 mm Pitch: 0.4 mm Pitch: 0.4 mm Pitch: 0.5 mm 64-pin FBGA (F1) Thickness: 0.69 mm 4 × 4 mm Pitch: 0.4 mm Pitch: 0.4 mm Pitch: 0.5 mm 64-pin WQFN ² (K8) Thickness: 0.75 mm 9 × 9 mm Pitch: 0.5 mm	80-pin LQFP (GC) Thickness: 1.4 mm 14 × 14 mm Pitch: 0.65 mm 80-pin LQFP (GK) Thickness: 1.4 mm 12 × 12 mm Pitch: 0.5 mm	100-pin LQFP (GF) Thickness: 1.4 mm 14 × 20 mm Pitch: 0.65 mm 100-pin LQFP (GC) Thickness: 1.4 mm 14 × 14 mm Pitch: 0.5 mm 100-pin FBGA ^{2.7} (F1) Thickness: 0.69 mm 6 × 6 mm Pitch: 0.5 mm	48-pin TQFP (GA) Thickness: 1.0 mm 7 × 7 mm Pitch: 0.5 mm 48-pin WQFN² (K8) Thickness: 0.75 mm 7 × 7 mm Pitch: 0.5 mm	Thickness: 1.4 mm 10 × 10 mm Pitch: 0.5 mm	Thickness: 1.11 mm 6×6 mm Pitch: 0.65 mm	64-pin TQFP (GA) 12 × 12 mm Pitch: 0.65 mm Pitch: 0.65 mm Pitch: 0.5 mm 64-pin TQFP (GA) Thickness: 1.0 mm 7 × 7 mm Pitch: 0.4 mm Pitch: 0.5 mm 64-pin FBGA (F1) Thickness: 1.11 mm 6 × 6 mm Pitch: 0.65 mm	14 × 14 mm Pitch: 0.65 mm	100-pin LQFP (GF) Thickness: 1.4 mm 14 × 20 mm Pitch: 0.65 mm 100-pin LQFP (GC) Thickness: 1.4 mm 14 × 14 mm Pitch: 0.5 mm	128-pin LQFP (GF) Thickness: 1.4 mm 14 × 20 mm Pitch: 0.5 mm	144-pin LQFP Thickness: 1.4 20 × 20 mm Pitch: 0.5 m

- *1 28 KB when the self programming function is used.
 *2 Under development
- *3 11 KB when the self programming function is used.

 *5 7 KB when the self programming function is used.

 *6 2 KB when the self programming function is used.
- *7 μPD78F1013 and 78F1014 only
- Remark The packages are shown in their actual size.

16 - b i t A I I F I a s h 2 0 1 0. 1 2

Large selection (2/2)

We offer flash microcontrollers in various packages and ROM or RAM sizes, allowing you to select the best flash microcontroller for your product or application.

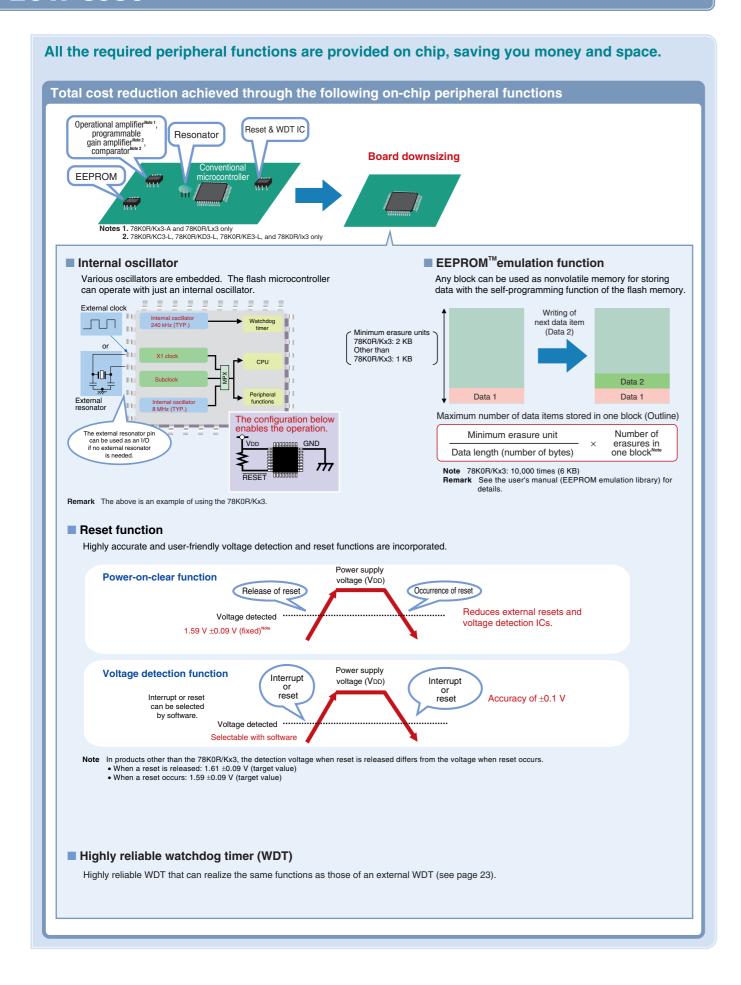
Commercial Name	78K0R/KF3-C	78K0R/KG3-C	78K0R/HC3	78K0R/HE3	78K0R/HF3	78K0R/HG3	μ PD78F8043	μ PD78F8058	78K0R/IB3		78K0R/IC3		78K0R/ID3	78K0R/IE3	78K0R/LF3	78K0R/LG3	78K0R/LH3
Pin Count ROM (bytes)	80-pin	100-pin	48-pin	64-pin	80-pin	100-pin	56-pin	56-pin	30-pin	38-pin	44-pin	48-pin	52-pin	64-pin	80-pin	100-pin	128-pin
512 K	Product name (RAM (bytes))																
384 K	78K0R	/Kx3-C	78K0R	/Hx3 Mi	crocont	rollers											
256 K	Microcol for Dig		μ PD78F1035* ¹ (16 K)	μ PD78F1040* ¹ (16 K)	μ PD78F1045 *¹ (16 K)	μPD78F1050*1 (16 K)	Microcontroller with On-Chip	Microcontroller							78	K0R/L	.x3
192 K	Applic		μ PD78F1034* ¹ (12 K)	μ PD78F1039* ¹ (12 K)	μ PD78F1044 * ¹ (12 K)	μPD78F1049* ¹ (12 K)	IO-Link Transceiver	with On-Chip RF Transceiver							Micro	ocontr	ollers
128 K	μ PD78F1847A (8 K*²)	μ PD78F1849A (8 K*²)	μPD78F1033*1 (8 K)	μ PD78F1038* ¹ (8 K)	μ PD78F1043* ¹ (8 K)	μPD78F1048* ¹ (8 K)	μ PD78F8043 (7 K)	μ PD78F8058* ¹ (8 K* ²)	78	K0R/lx	x3 Mic	rocor	ntrolle	rs		μ PD78F1505A , μ PD78F1515A (7 K)	μ PD78F1508A , μ PD78F1518A (7 K)
96 K	μ PD78F1846A (6 K)	μ PD78F1848A (6 K)	μPD78F1032*1 (6 K)	μ PD78F1037* ¹ (6 K)	μ PD78F1042 * ¹ (6 K)	μ PD78F1047* ¹ (6 K)	μ PD78F8042 (6 K)	μPD78F8057* ¹ (8 K* ²)		for I	nverte	er Con	trol		μ PD78F1501A (6 K)	μ PD78F1504A (6 K)	μ PD78F1507A (6 K)
64 K			μPD78F1031* ¹ (4 K)	μ PD78F1036* ¹ (4 K)	μ PD78F1041 * ¹ (4 K)	μPD78F1046* ¹ (4 K)	μ PD78F8041 (4 K)	μ PD78F8056* ¹ (8 K* ²)				μ PD78F1215 (3 K*³)	μ PD78F1225 (3 K*³)	μ PD78F1235 (3 K*³)	μPD78F1500A, μPD78F1510A (4 K)		μ PD78F1506A, μ PD78F1516A (4 K)
48 K												μ PD78F1214 (2 K)	μ PD78F1224 (2 K)	μ PD78F1234 (2 K)			
32 K							μ PD78F8040 (4 K)		μ PD78F1203 (1.5 K)	μ PD78F1213 (1.5 K)	μ PD78F1213 (1.5 K)	μ PD78F1213 (1.5 K)	μ PD78F1223 (1.5 K)	μ PD78F1233 (1.5 K)			
16 K									μ PD78F1201 (1 K)	μ PD78F1211 (1 K)	μ PD78F1211 (1 K)						
		100-pin LQFP (GC) Thickness: 1.4 mm 14 × 14 mm Pitch: 0.5 mm		64-pin LQFP (GB) Thickness: 1.4 mm 10 × 10 mm Pitch: 0.5 mm	80-pin LQFP (GK) Thickness: 1.4 mm 12 × 12 mm Pitch: 0.5 mm		56-pin WQFN (K8) Thickness: 0.75 mm 8 × 8 mm Pitch: 0.5 mm			38-pin SSOP (MC) Thickness: 1.7 mm 7.62 mm (300) Pitch: 0.65 mm	44-pin LQFP (GB) Thickness: 1.4 mm 10 × 10 mm Pitch: 0.8 mm	48-pin TQFP (GA) Thickness: 1.0 mm 7 × 7 mm Pitch: 0.5 mm	52-pin LQFP (GB) Thickness: 1.4 mm 10 × 10 mm Pitch: 0.65 mm	64-pin LQFP (GK) Thickness: 1.4 mm 12 × 12 mm Pitch: 0.65 mm		100-pin LQFP (GC) Thickness: 1.4 mm 14 × 14 mm Pitch: 0.5 mm	128-pin LQFP (GF) Thickness: 1.4 mm 14 × 20 mm Pitch: 0.5 mm
										•				P3 20 20 20 20 20 20 20 20 20 20 20 20 20			
Package							56-pin FBGA" (F1) Thickness: 0.91 mm 4×7 mm Pitch: 0.5 mm							64-pin LQFP (GB) Thickness: 1.4 mm 10 × 10 mm Pitch: 0.5 mm			

^{*1} Under development *2 7 KB when the self programming function is used. *3 2 KB when the self programming function is used. Remark The packages are shown in their actual size.

16 - b i t A I I F I a s h 2 0 1 0. 1 2

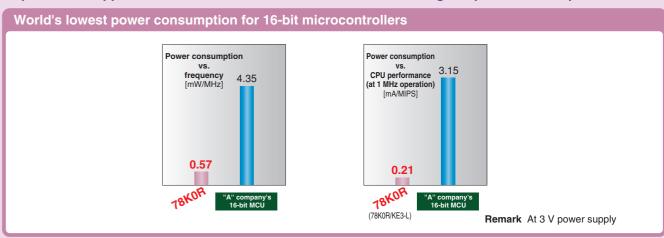
11

Low cost

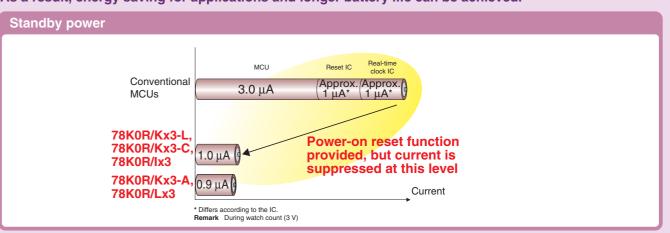


Low power consumption

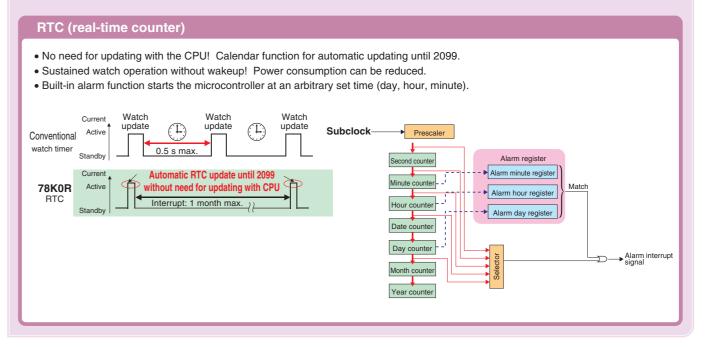
16-bit microcontroller performance combined with low power consumption Sophisticated application functions can be realized while maintaining low power consumption.



Lowered standby power consumption realized through lower standby current and enhanced watch count function As a result, energy saving for applications and longer battery life can be achieved.



Function that implements low power consumption has been added



16 - b i t A I I F I a s h 2 0 1 0. 1 2

Wide variety of products for specific applications (1/2)

We offer ideal products for various applications. You can choose the optimal product for your needs.

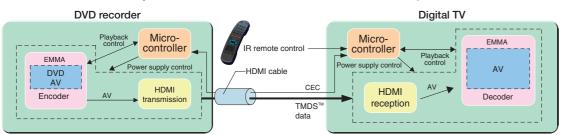
Microcontroller for digital AV applications (78K0R/Kx3-C)

1. HDMI™-CEC transmission/reception via hardware

Digital AV devices can be mutually controlled by simply connecting them via an HDMI cable.

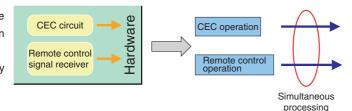
Example: Operation when a DVD is inserted into a DVD recorder

The TV is automatically switched on and the active channel is switched to video input.

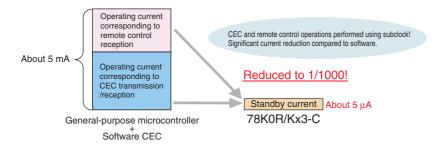


2. Improved system operability

The CEC circuit and remote control signal receiver are provided as hardware. CEC and remote control can therefore be processed simultaneously and easily. Development efficiency has been improved by reducing the labor required for developing software.



3. Operating current during HDMI-CEC transmission/reception reduced to 1/1000



4. Application evaluation board CEC-78K0R/KG3C provided to evaluate HDMI-CEC functions

The application evaluation board CEC-78K0R/KG3C expands the functions of the starter kit TK-78K0R/KG3C and enables application evaluation of the HDMI-CEC functions. A debugger*, compiler*, and circuit diagrams are included as standard, so that programs can be developed right away by connecting the board to a PC (*versions with limited functions). Furthermore, dedicated software to enable easy development of the CEC functions is also included. Specified CEC command transmission and CEC communication using the CEC data log can be reproduced and executed by using the dedicated software.



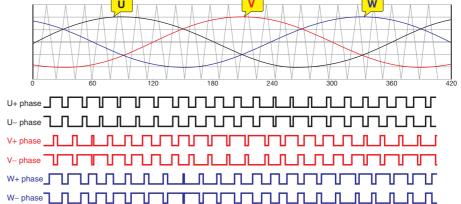
Remark HDMI (High-Definition Multimedia Interface): Standardized digital audio/video I/O interface for home electronics and AV devices CEC (Consumer Electronics Control): Control protocol (control method) for device control signals standardized by HDMI. By using CEC, multiple AV devices can be controlled by using one remote controller

Microcontroller for inverter control (78K0R/lx3)

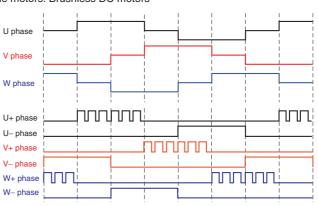
1. On-chip multi-function timer enabling fine inverter control

Twelve timer channels each having a 16-bit counter and a capture/compare register are provided in one unit. In addition to individual timer operations, multiple channels can be operated in conjunction to enable fine inverter control. Various waveforms can also be output.

Example 1: [6-phase triangular wave PWM output function (with dead time)] (180° excitation) Controllable motors: Brushless DC motors, AC motors

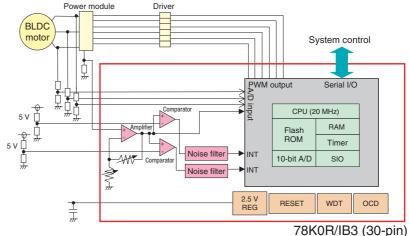


Example 2: [Non-complementary method modulation output function] (120° excitation) Controllable motors: Brushless DC motors



2. System minimization and cost reductions realized by incorporating circuits required for motor control





15

The circuits required for inverter control, such as the amplifier, comparators, noise filters, and A/D converter, which were conventionally provided as external circuits, have been incorporated into the microcontroller.

The number of components has been reduced to achieve system minimization and reduce costs.

Wide variety of products for specific applications (2/2)

We offer ideal products for various applications. You can choose the optimal product for your needs.

USB microcontrollers (78K0R/KC3-L, 78K0R/KE3-L)

1. USB 2.0 function interface included on the chip

To reduce componentry and reduce set size, we have integrated a USB 2.0 function interface on the microcontroller chip, so you do not have to connect an external USB chip.

We also provide a large number of endpoints so you can use our USB microcontrollers in a wide range of applications.

- USB specifications
- On-chip USB 2.0 function (full-speed) interface
- USB function interface endpoint configuration:

Two endpoints for Control transfers, two endpoints for Bulk transfers, and two endpoints for Interrupt transfers

• FIFO size: 64 bytes × 2 (Bulk transfer × 2)

64 bytes (Control transfer × 2, Interrupt transfer × 2)

■ All our USB microcontrollers are USB certified.



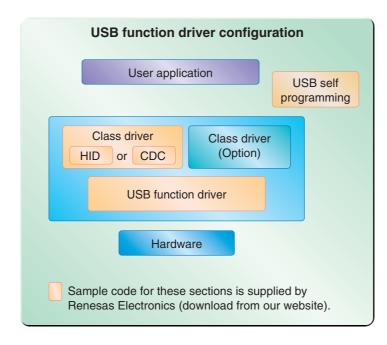
2. Extensive USB driver support

We supply drivers to implement USB function applications, helping you build your system

■ USB function driver

Renesas Electronics provides free sample code.

Remark HID: Human interface device CDC: Communication device class



3. Example applications







Healthcare equipment

Printer/scanners

POS peripherals

Microcontroller for industrial system sensors (μPD78F8043)

Renesas Electronics has commercialized the μPD78F8043, a 16-bit 78K0R microcontroller with an on-chip transceiver that can communicate with IO-Link devices. By using the μPD78F8043, you can build a sophisticated sensor network. We have also provided a software stack to help you develop your system more efficiently.

1. IO-Link

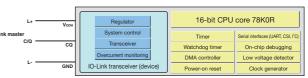
Many industrial systems today include controllers that operate in combination with multiple sensors and actuators. To respond to the increasing sophistication of these sensors and actuators, today's industrial systems must have capabilities such as acquiring quantitative data using digital communication as well as diagnostic features. IO-Link is a new and popular standard for standardizing communication between the controllers and sensors & actuators in industrial systems.

2. Features of IO-Link

- Used to connect controllers to sensors and actuators in industrial systems.
- Complies with the IEC61131-2 standard.
- Supports asynchronous serial communication and pulse modulation.
- Supports transmission and reception of quantitative data and parameters, and self-diagnosis.
- Maximum communication rate: 230.4 kpbs
- Point-to-point connection
- Operating mode can be switched between IO-Link communication mode and standard I/O mode.
- Existing cables (M12, etc.) can be used.

3. µPD78F8043 microcontroller with on-chip IO-Link transceiver

- A 16-bit 78K0R microcontroller with an on-chip IO-Link device
- Includes a DMA controller to reduce the software load when transferring data.
- Has overcurrent and wakeup detection capabilities.
- We provide a software stack for IO-Link communication that lets you concentrate on developing your application.



RF microcontroller (µPD78F8058)

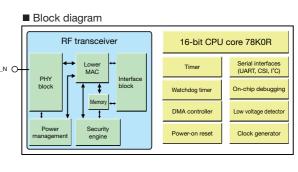
1. Microcontroller and RF transceiver integrated into a single package

The µPD78F8058 integrates a 16-bit microcontroller and 2.4 GHz RF transceiver into a single package. Now you can design your system without having to add an external RF transceiver.

Your system will have fewer components and can be made much smaller.

■ RF transceiver specifications

- O Complies with IEEE802.15.4-2006 (modulation system: O-QPSK, spread system: DSSS, communication rate: 250
- 16 channels operating in a 2.405 to 2.480 GHz ISM band
- Sensitivity: -95 dBm, input level: 3 dBm (max.)
- RSSI (received signal strength indicator) ADC
- and I/Q (in-phase/quadrature phase) DAC included
- Auto ACK response
- Security engine



17

2. Supportive development environment

Renesas Electronics provides an RF transceiver-compliant starter kit—the TK-RF8058+SB (from TESSERA Technology Inc.)—which you can use to develop a small-scale, low-power wireless communication system See Connecting (ZigBee®) on the Application examples page for details.

3. Example applications

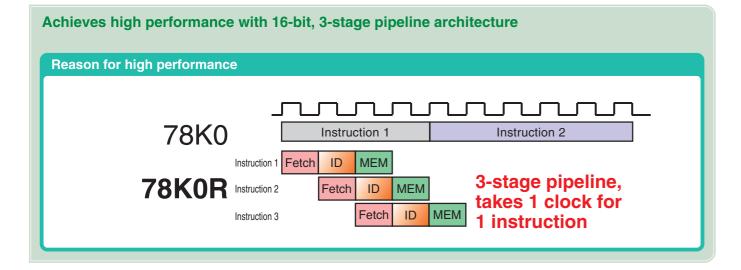
Wireless remote control (RF4CE compliant)

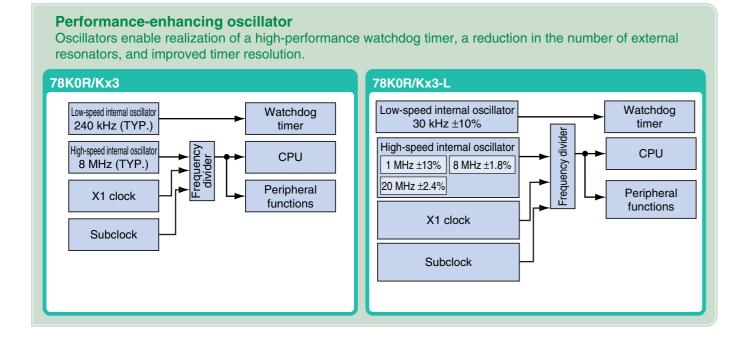
Digital TVs

Water meters, power meters, etc.

High performance and functionality (1/2)

High-performance CPU embedded We provide reliable performance for system function expansion. Performance equivalent to 16-bit microcontrollers At 24 MHz operation 30.5 MIPS **78K0R** Other 11 company's 16-bit MCU A Performance (MIPS) 10 (Dhrystone 2.1)





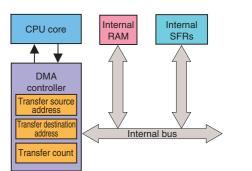
Functions for enhancing performance Reduces the CPU processing load.

Data exchanges can be performed automatically between the special function registers (SFRs) of the peripheral hardware and the internal RAM without the CPU, using interrupts from the timer, serial interface, or A/D converter, or software triggers.

- Number of channels: 4 (78K0R/Hx3), 2 (other than 78K0R/Hx3)
- Transfer unit: 8 bits/16 bits
- Maximum number of transfers: 1024
- Transfer type: 2-cycle transfer
- Transfer mode: Single transfer mode
- Transfer targets: SFRs ↔ internal RAM

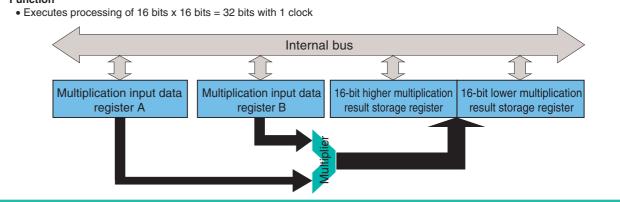
Applications

- CSI, UART (continuous transfer)
- A/D converter (continuous read of analog data, etc.)
- Timer (A/D conversion result, port value read, etc., at fixed intervals) • Software trigger (DMA startup trigger can be generated through

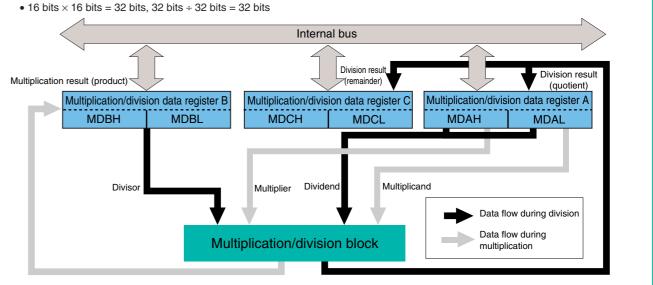


19

Multiplier (78K0R/Kx3)



Multiplier/divider (78K0R/Kx3-L, 78K0R/Kx3-C, 78K0R/Hx3, 78K0R/Ix3, 78K0R/Kx3-A, 78K0R/Lx3, μPD78F8043, μPD78F8058) Function



18 16 - b

High performance and functionality (2/2)

Enhanced functions for greater user friendliness Timer array unit On-chip timer unit incorporating one 16-bit counter and one capture/compare register per channel In addition to standalone operation of each timer, many different functions can be realized by operating multiple channels together. In the case of the 78K0R/KG3: **Functions** Interval timer • Input signal high-/low-level width measurement • Interval counting for up to 8 channels is possible. • Frequency divider function • PWM output • PWM output for up to 7 channels is possible. • External event counter · One-shot pulse output Inverter control (78K0R/lx3 only) In the case of the 78K0R/lx3: • Input pulse interval • 3-phase sine-wave PWM output and 2-phase measurement modulation are possible. • Half-bridge drive for 2 channels is possible. Clock · Full-bridge drive is possible. PWM output through combination of multiple timers 16-bit counter register ch 0 (cycle) External input ch 1 (duty) ch1 Pin J ch 2 (duty)

Serial array unit

The serial array unit provides one shift register and one buffer register per channel, allowing the configuration of a 3-wire serial communication function and simple I2C function with one channel. Using two channels, a full-duplex UART function can be realized.

The following serial communication functions can be selected.

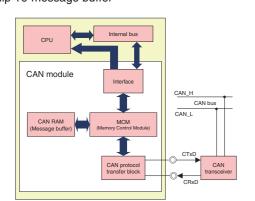
- CSI • UART
- → Interrupt signal Serial data output → Interrupt signal

n: Even-number channel, m: Odd-number channel Note Implemented functions differ depending on the product

• Simple IIC nnel Combination Example <2> reception CSI transr

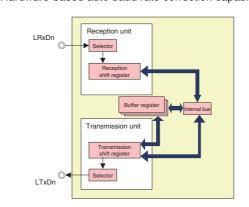
CAN controller (78K0R/Hx3)

- · Complies with CAN protocol standard ISO 11898.
- Both standard and extended frames can be sent and received.
- Transfer rate: Up to 1 Mbps
- On-chip 16-message buffer



LIN-UART (78K0R/Hx3)

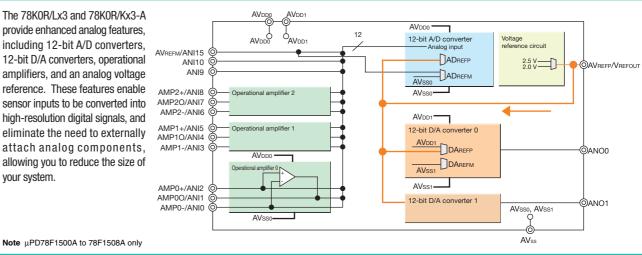
- · Communication using 9-bit data possible
- Transfer rate: Up to 1 Mbps
- On-chip 18-message buffer (using 2 channels)
- Hardware-based auto baud rate correction capability (slave)



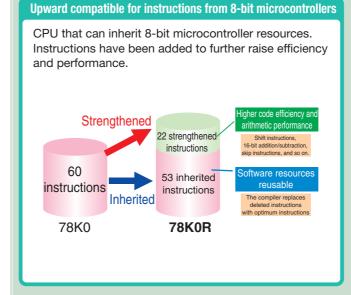
LCD controller/driver (78K0R/Lx3) Three different display methods can be selected according to the LCD application. vailability of 8 common signals External resistive division

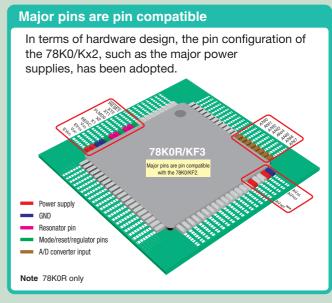
Enhanced analog features (78K0R/Lx3^{Note}, 78K0R/Kx3-A)

The 78K0R/Lx3 and 78K0R/Kx3-A provide enhanced analog features. including 12-bit A/D converters. 12-bit D/A converters, operational amplifiers, and an analog voltage reference. These features enable sensor inputs to be converted into high-resolution digital signals, and eliminate the need to externally attach analog components, allowing you to reduce the size of your system.



Shifting to high-performance 16-bit microcontrollers can be performed smoothly, taking compatibility with 8-bit microcontrollers into consideration.





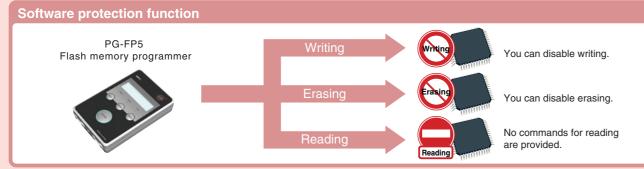
20 16 - b i t

High reliability

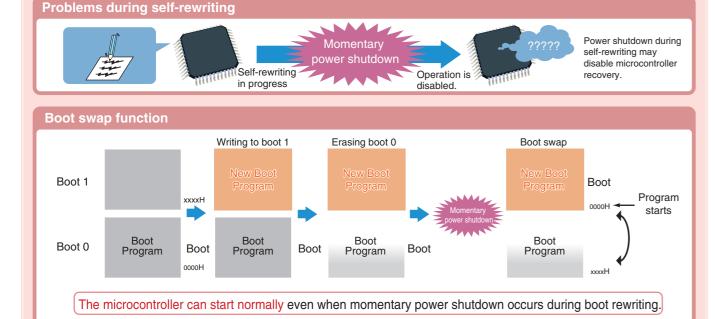
The reliability technologies developed for automotive flash microcontrollers can be found in all our flash microcontrollers, making them a safe choice.



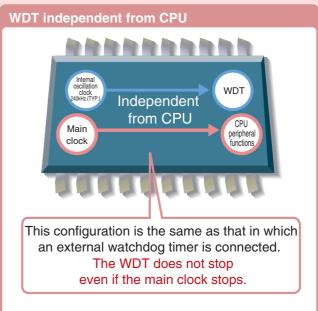
A flash security setting function is provided to protect your software from malicious rewriting and reading.

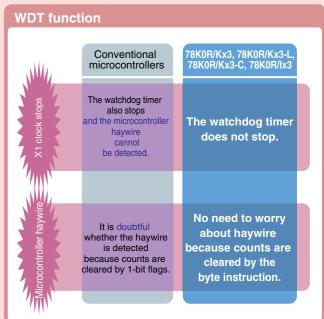


A boot swap function is provided to protect important programs even when power shuts down during self-programming.



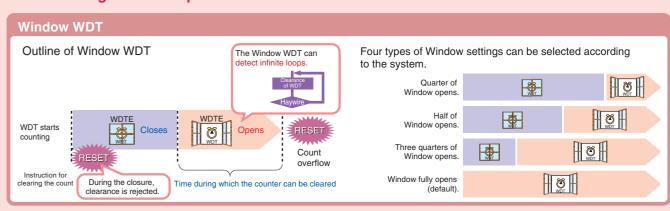
The enhanced watchdog timer (WDT) offers improved reliability and functionality equivalent to that of an external WDT.



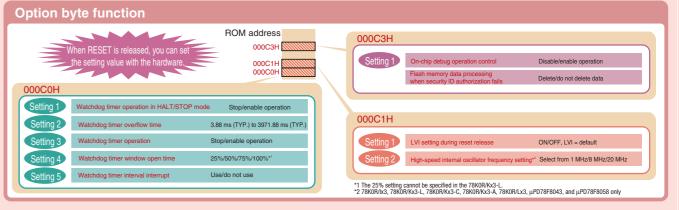


23

The watchdog timer incorporates enhanced functions.

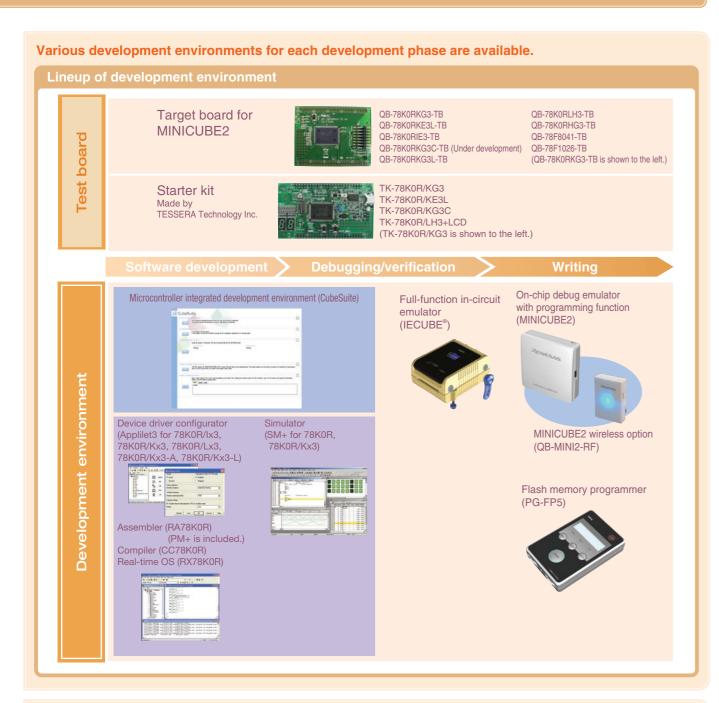


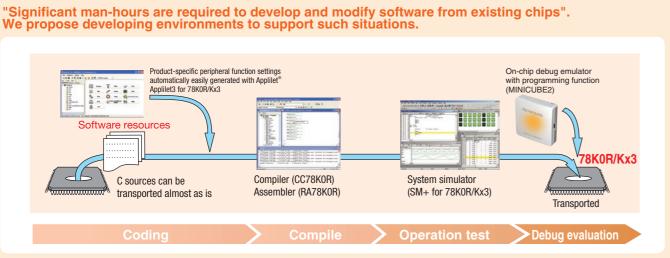
An option byte function is incorporated to enable important system operation settings by hardware, eliminating setting errors caused by inadvertent program loops.

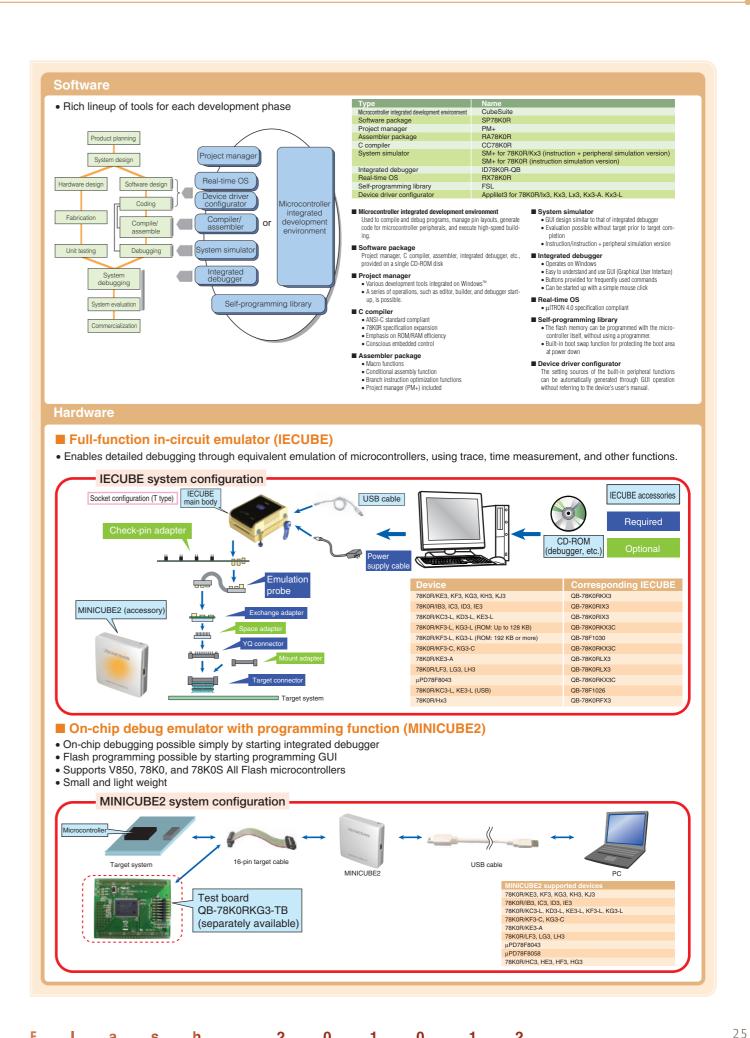


16 - bit All Flash 2010.12

Rich development environment



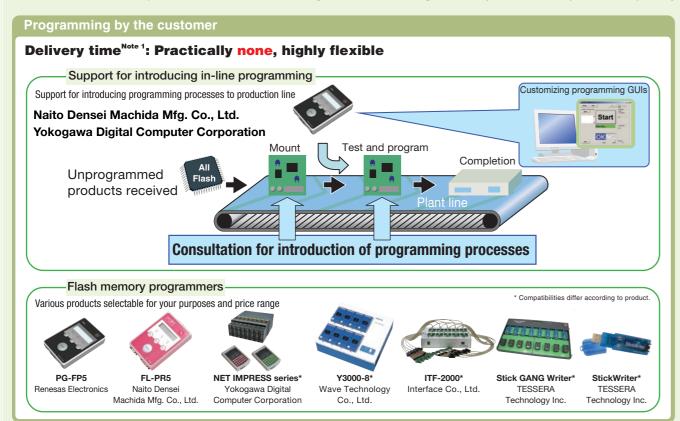




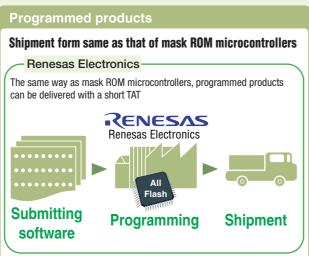
Support for mass production

Mass production support environment for your needs.

You can select the mass production method with the largest merit, according to delivery time or mass production quantity.







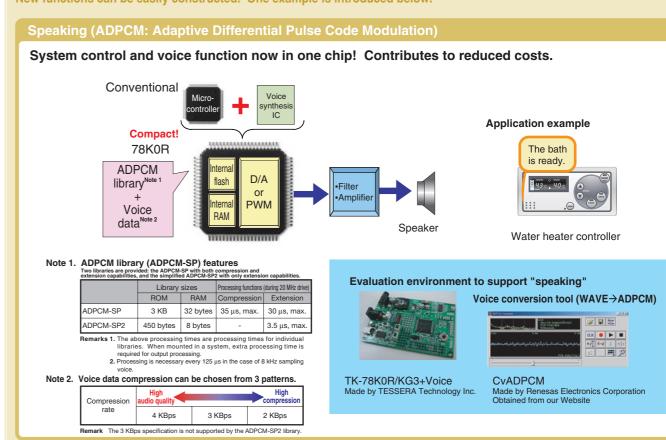


Notes 1. Period from completion of software until start of mass production

2. Delivery time may vary depending on purchase conditions, such as order quantity.

Application examples

Various functions achieved with 78K0R All Flash features and libraries New functions can be easily constructed. One example is introduced below.



Connecting (ZigBee®)

Our All Flash microcontrollers comply with ZigBee PRO, providing total support for low-power wireless network applications. You can start developing your application straight away.

 ZigBee PRO, SimpleNET applica · Build a low-power in-home network Supports 8, 16, and 32-bit microcontrollers

RF4CE (wireless remote control) application -

Evaluation board lineup (Boards made by TESSERA Technology Inc.) TK-78K0R/KG3+UD

16-bit microcontroller 78K0R/KG3 mounted

Internal ROM: 512 KB - Internal RAM: 30 KB

TK-RF8058+SB

16-bit microcontroller with RF receiver µPD78F8058 mounted

Internal ROM: 128 KB

- Internal RAM: 8 KB

78K0R UD Stick



16-bit microcontroller 78K0R/KE3 mounted

Internal ROM: 256 KB

- Internal RAM: 12 KB

27



A protocol stack library that enables the establishment of wireless communication, diagnosis, and debugging through the use of Network Viewer, Sniffer, and other tools on your computer

- The kit supports the ZigBee PRO, SimpleNET, and RF4CE standards.

Note Product co-developed by Skyley Networks, Inc. and Renesas Electronics.

The remote controller is omnidirectional so you do not have to point it at the device. Bidirectional communication allows

the device status to be displayed on

the remote controller's screen.

16 - b

Product specifications (1/4)

Commercial name	e		78K0R/KE3 78K0R/KF3							78K0R/KG3							78K0R/KH3						78	BKOR/K	J3					
Pin count					64-pin				80-pir	1					100-pir	า					128-pin					144-pin				
Product name			µPD78F1142A	PD78F1143A	PD78F1144A -	PD78F1145A	PD78F1146A	PD78F1152A	PD78F1154A .	PD78F1155A	PD78F1156A	PD78F1162A	PD78F1163A	PD78F1164A	PD78F1165A	D78F1166A	PD78F1167A	PD78F1168A	PD78F1174A	PD78F1175A	PD78F1176A	PD78F1177A	PD78F1178A	PD78F1184A	PD78F1185A	PD78F1186A _	PD78F1187A	PD78F1188A		
Flash memory (by	/tes)		=. 64 K	±. 96 K	128 K	192 K	256 K	64 K 9	i i i i i i i i i i i i i i i i i i i	192 K	256 K	54 K	±. 96 K	128 K	±. 192 K	生 256 K	384 K	512 K	128 K	192 K	±. 256 K	384 K	512 K	±. 128 K	±. 192 K	±. 256 K	384 K	±. 512 K		
RAM (bytes)	,,		4 K	6 K	8 K		12 K ^{Note 1}		K 8 K	10 K	12 K ^{Note 1}	4 K	6 K	8 K	10 K	12 K ^{Note 1}	24 K	30 K ^{Note 2}	8 K	10 K	12 K	24 K	30 K ^{Note 2}	8 K	10 K	12 K		30 K ^{Note 2}		
External bus	External memo	ory expansion space			-				-			888 K	824 K	824 K	760 K	696 K	568 K	440 K	824 K	760 K	696 K	568 K	440 K	824 K	760 K	696 K	568 K	440 K		
interface	Bus type				-				-					Multi	olexed/sep	parate				Multip	plexed/sep	parate			Mult	iplexed/sep	arate			
	Address bus				-				-					Selectable	from 8, 12	, 16, and 2	0			Selectable	from 8, 12	, 16, and 2	.0		Selectable	from 8, 12,	16, and 20	0		
	Data bus				-				-						8/16 bits						8/16 bits					8/16 bits				
Power supply	Normal operat														1.8 to 5.5															
voltage		programming mode													2.7 to 5.5															
Minimum instruct																		$V_{DD} = 1.8 \text{ to}$	5.5 V)											
CIOCK		High-speed system clock											Cer	amic/crysta			20 MHZ													
	Subclock	High-speed internal oscillation clock													8 MHz (Ty stal: 32.76															
		ernal oscillation clock													Hz (Typ.) (
I/O ports	Total	occination older			55				70					270 KI	88						116					132				
	CMOS I/O				46				61						79						107					123				
	CMOS input				4				4						4						4					4				
	CMOS output 1							1 1 1									1													
	N-ch open-drain	1			4				4						4						4			4						
Timer	16-bit timer	Number of channels			8				8						8						12					12				
		Function						l	terval timer/ex	ternal even	nt counter/fro	equency	division f	unction/pul	se interval	l measuren	nent/pulse	width meas	urement/c	one-shot pu	lse output	/PWM outp	out							
		PWM		6 (channels m	ıax.			7 channels i	nax.				7 c	hannels m	nax.				10 (channels n	nax.			10	channels m	ax.			
	Watchdog time	(WDT)			1				1						1						1					1				
	Real-time count								1						1						1					1				
Serial interface		s, UART: 1 channel		-				1				1								1					1					
		, UART: 1 channel			1				-			-									-					-				
		RT: 1 channel, simple l ² C: 2 channels			-				-						-						2					2				
		ART: 1 channel, simple I ² C: 1 channel ART (supporting LIN): 1 channel			-				_			2									_					_				
		, simple I ² C: 1 channel						-					-								_									
	CSI	, dimplo i d. i dilainidi			_				_	-									_					_						
		el, simple l ² C: 1 channel			-				-										-					-						
	UART (suppor	ting LIN)			1				1						1						1					1				
	UART				-				-						-						-					-				
	Simple I ² C				-				-						-						-					-				
	I ² C				1				1						1						1					1				
LCD controller/dr					-				-						-						-					-				
	Segment signa				-				-						-						-					-				
A/D	Common signal output –																		- 40 hita 40											
A/D converter D/A converter					10 bits × 8	•																				10 bits × 16 8 bits × 2				
DMA controller		2													8 bits × 2		2													
Interrupt	External				13				13		13									13					13					
	Internal				25				28						28						32					32				
On-chip debug (N																ed														
Multiplier/divider			Supported Multiplier: 16 bits × 16 bits = 32 bits																											
Low-voltage dete	ctor (LVI)		1.91/2.07 (initial value)/2.22/2.38/2.53/2.68/2.84/2.99/3.15/3.30/3.45/ 3.61/3.76/3.92/4.07/4.22 V ±0.1 V (selectable by software), low-voltage detection for an external input pin (EXLVI) can be performed																											
Power-on clear (F	POC)		1.59 V ±0.09 V																											
Other peripheral	functions													Key	interrupt f	unction														
Operating temper	rature														-40 to +85	5°C														
Nata d do KD		ramming function is used																												

Notes 1. 10 KB when the self programming function is used.
2. 28 KB when the self programming function is used.

Product specifications (2/4)

Commercial name						78K	0R/KC3-L					78K0	R/KD3	-L	78K0F	R/KE3-		7	8K0R/K	=3-L		7	8K0R	/KG3-	·L	78F	(OR/KC	3-L	78K0R/KE3-L	. 78K	0R/KE	3-A
Pin count			40-	-pin			44-pin			48-pin			52-pin			-pin			80-pir				100				48-pin		64-pin		64-pin	
Product name		9	_		8	0		8		ارام 10 ا	9	4		9	~	80 0		0 +	- 0	-	-	ო	4	2 Pill	- T		το pin	4	10 (0	ဖ	0+ pii1	8
		JPD78F1000	PD78F100	LPD78F1002	LPD78F100	LPD78F1000	PD78F1001	LPD78F100	.PD78F100	LPD78F100	PD78F100	LPD78F100	PD78F1005	LPD78F100	(PD78F100	(PD78F100		LPD78F101	IPD/8F101	PD78F1027 ^{Not}	PD78F1028 ^{Not}	1PD78F1013	LPD78F101	PD78F1029 ^{Not}	PD78F1030 ^{Not}	LPD78F1022	"PD78F102	₁ PD78F102	LPD78F102	₁ PD78F101	₁ PD78F101	LPD78F101
Flash memory (by	vtes)	16 K	32 K	48 K	64 K	16 K	32 K 48 k	64 K	32 K	48 K	64 K	32 K	48 K	64 K	32 K	8 K 64	K 64	4 K 96	6 K 128 K	192 K	256 K	96 K	128 K	192 K	256 K	64 K	96 K	128 K	96 K 128 K	64 K	96 K	128 K
RAM (bytes)	,	1 K			3 K ^{Note 2}				1.5 K	2 K			2 K			2K 3K			K 8 K ^{Note 3}		12 K ^{Note 4}		8 K ^{Note 3}		12 K ^{Note 4}				8 K ^{Note 3} 8 K ^{Note 3}		6 K	7 K
External bus	External memory expansion space						-						_			_			_					_				_			_	
interface	Bus type						_						_			_			_				-	_				_			_	
	Address bus						_						_			_			_				_	_				_			_	
	Data bus						_						_			_			_				_	_				_			_	
Power supply	Normal operation mode												1.8 to	5.5 V												3.0 to 3	.6 V (1.8 to	3.6 V wh	en USB not used)	1.8 to 5.5	V
voltage	Flash memory programming mode												1.8 to	5.5 V														1.8 to 3.6			1.8 to 5.5	
Minimum instruct	ion execution time								0	.05 μs (20	MHz· Vi	nn = 2 7 to			s (5 MHz: Vi	n = 1.8 to :	27V)									0.05 us (20			(5 MHz: V _{DD} = 1.8 to 3.6 V			
Clock	Main clock High-speed system clock								0.	.00 μο (20		Ceramic			al clock: 2														ock: 2 to 20 MHz			
	High-speed internal oscillation clock									1 N		3%, 8 MHz	•		Hz ±2.4%	0 20 1111 12											MHz ±13% (ta	raet). 8 MHz	±1.8% (target).	1 MHz ±13	3% (target), 8 N	//Hz ±2%
	Subclock									1 1	12 ±10	75, O IVII 12	2 ±1.0 /0,		ystal: 32.76	8 kHz												Hz ±2.4% (tai			20 MHz ±2.4% al: 32.768	
	Low-speed internal oscillation clock											30 FH	Iz ±10%	(for W	-	O IXI IZ											30 kHz				±10% (for	
I/O ports	Total			33			37			41		30 KH	45	(101 VV		55			71				0	19			39 ^{Note 5}	_10 % (10	53 ^{Note 5}	OU KI IZ	53	.,,,,
	CMOS I/O			31			33			34			38			33 48			62					10			39		43		46	
	CMOS input		3	2			4			J4			J0			1			62				8	4			4		43		40	
				2			4			4			4			4			4				-	4			-		4		4	
	CMOS output			_			-			0			0			0			1					4			-		1		0	
Timar	N-ch open-drain			_			-			2			2			2			4					4			4		4		2	
Timer	16-bit timer Number of channels		i	8			. 8			8			8			8			12				1	2			8		8	Interval timerlayte	12	au canou divinion
	Function				In	nterval tin	ner/external ev	ent count	ter/frequer	ncy divisio	on functi	ion/pulse	interval	measi	urement/pu	lse width i	measure	ement/on	e-shot pulse	output/P	WM outp	out							division function/pulse interva hot pulse output/PWM output	function/pulse	ernal event counter/fre interval measuremer	rt/pulse width
	DWM		0				7 -		7 - 1			7 -1	h -		7				40				40 ah a				•				one-shot pulse outpu	
	PWM		6 chann	ieis max.	-		7 channels ma	ıx.	/ Cr	nannels m	ax.	/ CI	hannels	max.	7 chan	nels max.			10 channels	max.			10 chann	ieis max	(.	30	hannels m	iax.	5 channels max	. / CI	nannels m	ax.
	Watchdog timer (WDT)			1			1			1			1			1			- 1								1		1		1	
Serial interface	Real-time counter (RTC)			_			- 1			'			- 1			1			1	0			4	I	0		- 1		<u>'</u>		- 1	
Serial illierrace	CSI: 2 channels, UART: 1 channel			_			-			_			_			_			ı	2			1		2		_		_		_	
	CSI: 1 channel, UART: 1 channel			_			-			-			-			-			-				-	-			- 1		'		- 1	
	CSI: 2 channels, UART: 1 channel, simple I ² C: 2 channels			_			-			-			-			_			-				-	-			_		_		-	
	CSI: 1 channel, UART: 1 channel, simple I ² C: 1 channel			1			1			1			1			1			2				2	2			- 1		2		2	
	CSI: 2 channels, UART (supporting LIN): 1 channel			1			1			1			1			1			-				-	-			_				_	
	CSI: 1 channel, simple I ² C: 1 channel			_			-			-			-			-			-				-	-			-		-		-	
	CSI			-			-			-			-			-			_				-	-					_		_	
	UART: 1 channel, simple I ² C: 1 channel			-			-			-			-			-			-				-	-			-		-		-	
	UART (supporting LIN)			_			-			-			-			-			1				1	1			1		1		1	
	UART			-			-			-			-			-			-				-	-			-		-		-	
	Simple I ² C			-			-			-			-			-			-				-	-			-		_		-	
	ı²c			-			-			1			1			1			1				1	1			1		1		1	
LCD controller/dr				-			-			-			-			-			-				-	-			-		-		-	
	Segment signal output			-			-			-			-			_			-				-	-			-		-		-	
	Common signal output			-			_			_			-			-			_				-	-			_		-		_	
A/D converter			10 bit	ts × 10			10 bits × 10		1	0 bits × 11	1	10 1	bits × 11		10 b	its × 12			10 bits ×	12			10 bit	s × 16			10 bits \times 8	3	10 bits × 8		2 bits × 12	
D/A converter				-			-			-			-			-			-				-				_		-		12 bits × 2	
DMA controller				2			2			2			2			2			2				2				2		2		2	
Interrupt	External			8			9			9			9			9			13					3			7		11		12	
	Internal		2	22			24			25			25			25		3	33	3	5	3	3	3	35		36		41		33	
On-chip debug (M	IINICUBE2)												pported															upported			Supported	
Multiplier/divider Low-voltage dete	Itiplier/divider w-voltage detector (LVI)			07 (initial	value)/2.	22/2.38/	2.53/2.68/2.84	/2.99/3.15	Multiplier 5/3.30/3.4						s ÷ 32 bits :				s ion for an ex	ternal inp	ut pin (E	XLVI) ca	ın be per	formed	Multiplier/divider: 16 bits × 16 bits = 32 bits, 32 bits + 32 bit 1.91/2.07 (initial value)/2.22/2.38/2.53/2.68/2.84/2.99/3.15/3.30/3.45 V±0.1 V (selectable by software), low-voltage detection for an external input pin (EXLVI) can be performed					5	Note 6	: 32 bits
Power-on clear (P	Power-on clear (POC)									Power	on rese	et: 1.61 V	±0.09 V,	power	r-down rese	t: 1.59 V ±	0.09 V									Power			0.09 V, power-d	own reset	: 1.59 V ±	0.09 V
Other peripheral t	ther peripheral functions						Comparator	2 channe	els, progra	ammable g	gain amp	plifier: 1 c	channel,	key in	nterrupt fun	tion	K	ey interru	upt function		Ke	y interru	pt function	on		USB fu	nction cont	roller, key	interrupt function	Operational ampl	ifier: 3 channels, key i	iterrupt function
Operating temper	rature												-40 to	+85°C)												-4	0 to +85°	C		10 to +85°	0
Notes 1 Under d	potes 1. Under development		lotos 4	11 KR w	han tha s	elf progr	amming functi	on is use	d																							

2. 2 KB when the self programming function is used.
 3. 7 KB when the self programming function is used.

Notes 4. 11 KB when the self programming function is used.

5. One is for controlling the USB buffer.

6. 1.91/2.07 (initial value)/2.22/2.38/2.53/2.68/2.84/2.99/3.15/3.30/3.45/3.61/3.76/3.92/4.07/

4.22 V ±0.1 V (selectable by software), low-voltage detection for an external input pin (EXLVI) can be performed

Product specifications (3/4)

Commercial name	78K0R/KF	3-C 78	K0R/KG	3-C		78K0R/	HC3		78K	(OR/HE	E3 ^{Note 1}				78K	0R/HF	3 ^{Note 1}			78K	DR/HG3	Note 1		μ	PD78	F8043		μ PD78	F8058	B ^{Note 1}				
Pin count			80-pir		100-pii	n		48-pi	n				64-pin					80-pir					100-pin	1			56-	pin		5	6-pin			
Product name			₹ p	₹	<u>≪</u>	Ψ.	E 00	က္က	. 7	22	9		<u> </u>	6	9	Ξ	24	<u>ස</u>	4	τĊ	9	7	<u> </u>		00	6	-	5	13	99	24	80		
			uPD78F1846	urD/8F184	uPD78F184	uPD78F1849	JPD78F1031	1PD78F103	1PD78F103	1PD78F103	1PD78F103	LPD78F103	1PD78F103	1PD78F103	.PD78F10∠	ıPD78F10∠	"PD78F10∠	1PD78F10∠	1PD78F10∠	μPD78F10∠	1PD78F10∠	1PD78F10∠	1PD78F10∠	"PD78F10∠	"PD78F105	μPD78F80.	µPD78F80	µPD78F80	µPD78F80	µPD78F80	µPD78F80(µPD78F80		
Flash memory (by	/tes)		96 K 12	8 K 9	96 K 12	18 K	64 K 96	K 128 K	192 K	256 K	64 K	96 K	128 K	192 K	256 K	64 K	96 K	128 K	192 K	256 K	64 K	96 K	128 K	192 K	256 K	32 K	64 K	96 K	128 K	64 K	96 K	128 K		
RAM (bytes)	· · ·		6 K 8 K	Note 2	6K 8K	Note 2	4 K 6 H	(8 K	12 K	16 K	4 K	6 K	8 K	12 K	16 K	4 K	6 K	8 K	12 K	16 K	4 K	6 K	8 K	12 K	16 K	4 K	4 K	6 K	7 K	8 K ^{Note 2} 8	3 K ^{Note 2}	8 K ^{Note 2}		
External bus	External memor	y expansion space	-		-			-					-					-					-				-				-			
interface	Bus type		-		-			_					-					-					_				-				-			
	Address bus		-		-			-					-					-					-				-				-			
	Data bus		-		-			_					-					-					_				-				-			
Power supply	Normal operation	n mode		2.7 to 5.5	5 V										2.7 to	5.5 V											3.0 to	5.5 V		1.8 to 3.6 V				
voltage	Flash memory p	rogramming mode		2.7 to 5.5	5 V										2.7 to	5.5 V											3.0 to	5.5 V		1.8	3 to 3.6 V	,		
Minimum instruct	ion execution time		0.05 μs (20 l	MHz: VDD	= 2.7 to 5.	.5 V)								42 n	s (24 MHz	V _{DD} = 2.7	7 to 5.5 V))								0.05 μs (20	MHz: \	$I_{DD} = 3.0 \text{ t}$	o 5.5 V)	0.05 μs (20 MHz: V₁₀ = 2.7 to 3.6 V), 0.2 μs (5 MHz: V₁₀ = 1.8 to 3.6 V)				
Clock	Main clock	ligh-speed system clock	Ceramic/crysta	/external	clock: 2 to 20) MHz								Cera	mic/crysta	l/external	clock: 2 t	to 20 MH	Нz							Ceramic/crys	al/extern	al clock: 2	o 20 MHz	1Hz Ceramic/crystal/external clock: 2 to 20 MH				
	H	ligh-speed internal oscillation clock	8 MHz ±2% (ta	rget), 20 l	MHz ±2% (ta	arget)								4 MH	z <u>+</u> 2% (tar	get), 8 MF	Hz <u>+</u> 2% (t	target)								1 MHz (typ.)	8 MHz	(typ.), 20 N	1Hz (typ.)	1 MHz (typ.), 8 h	MHz (typ.), 2	0 MHz (typ.)		
	Subclock		Crys	tal: 32.7	68 kHz										-												-			Crystal: 32.768 kHz				
	Low-speed inte	rnal oscillation clock	30 kH:	±10% (1	for WDT)									30	0 kHz ±109	% (for WD	T)									30 k	Hz ±10%	6 (for WD	Γ)	30 kHz ±	10% (for	WDT)		
I/O ports	Total		71		89			41					55					71					89				26 ^N	ote 3		-	18 ^{Note 5}			
	CMOS I/O		62		80		32						46					62					80				2	3			13			
	CMOS input 4 4						4						4					4					4				1				4			
	CMOS output		1		1			1					1					1					1				_				1			
	N-ch open-drain		4		4			4					4					4					4				2				_			
Timer	16-bit timer	Number of channels	11		11			17					21					21					25				1:	2			12			
		Function	Interval timer/external even					Interval	timer/exte	rnal event	counter/f	requency	division	funct	ion/pulse i	nterval m	easureme	ent/pulse	e width me	easureme	nt/one-sh	ot pulse o	utput/PWI	M output		Interval timer/exter		nter/pulse width tput/PWM outpu		Interval timer/ext interval measureme one-shot pul:		measurement/		
		PWM	9 channels r	nax. 9	channels r	nax.		14 channels	max.			17 (channels	max.		17 channels max.						21 (channels m	nax.		6	channe	els max.		2 cha	nnels m	ax.		
	Watchdog timer (WDT)	1		1			1					1			1						1				1				1				
	Real-time counte	r (RTC)	1		1			_					-					-					_				-				1			
Serial interface	al interface CSI: 2 channels, UART: 1 channel				1			_					-					-					-				-				-			
	CSI: 1 channel,	UART: 1 channel	-		-			_	-				-					-					-				-				-			
	CSI: 2 channels, UAR	T: 1 channel, simple I ² C: 2 channels	_		_		-					-						-					-				-				-			
	CSI: 1 channel, UAF	T: 1 channel, simple I ² C: 1 channel	2		2			-			-							-					-				1				1			
	CSI: 2 channels, UA	RT (supporting LIN): 1 channel	-		-		-			-							-					-				-				-				
	CSI: 1 channel,	simple I ² C: 1 channel	-		-			-					-					-					1				-				-			
	CSI		-		-			2					3					3					3				-			1 (used exclusively for intern	nal communication wi	ith the RF transceiver)		
	UART: 1 channe	I, simple I ² C: 1 channel	-		-			-					1					1					1				-				-			
	UART (supporti	ng LIN)	-		-			2					2					2					2				1				1			
	UART		-		-			-					-					-					-			1 (used exclusively for	nternal commu	nication with the IO	Link transceiver)	1 (trans	mission	only)		
	Simple I ² C		-		-			1					1					1					-				-				-			
	I ² C		1		1			-					-					-					_				1				-			
LCD controller/dr	iver		-		-			-					-					-					-				-				-			
	Segment signal	output	-		-			-					-					-					-				-				-			
	Common signal	output	-		-			-					-					-					-				-				-			
A/D converter			10 bits × 1	2	10 bits × 1	16		10 bits ×	11			10	bits × 15				1	10 bits × 1	16				10 bits × 24	4			10 bit	s×6			-			
D/A converter			-		-			-					-					-					-				-				-			
DMA controller			2		2			4					4					4					4				2				2			
Interrupt	External		9		9			10					11					12					12				5 ^{No}	te 4			4			
	Internal		35		35			41					47					47					49				2	3			27			
On-chip debug (N	IINICUBE2)			Support											Supp	orted											Supp				upported			
Multiplier/divider Low-voltage dete	Itiplier/divider w-voltage detector (LVI))/3.45/3.61/3 y software),	× 16 bits = 32 remainder: 3 3.76/3.92/4.07/4 , low-voltage de VI) can be perfo	4.22 V tection		2.84/2.99/3	.15/3.30/3.	45/3.61/3.		er/divider: 4.07/4.22			ts = 32 bit ectable by							ı (EXLVI)	can be per	rformed		Multiplier/divider: 16 bits × 16 bits = 32 bits bits + 32 bits = 32 bits, remainder: 32 bit 3.15/3.30/3.45/3.61/3.76/3.92/4.07/4.22 V ±0 (selectable by software), low-voltage detection an external input pin (EXLVI) can be perform			$2 V \pm 0.1 V$ etection for	1.91/2.07 (initial value)/ /3.30/3.45 V ±0.1 V (se	/2.22/2.38/2.53/2.telectable by softw	.68/2.84/2.99/3.15 vare), low-voltage		
Power-on clear (F	Power-on reset: 1.61 V	0.09 V, power	r-down reset: 1.59 \	/ ±0.09 V						Power-o	n reset:	1.61 \	ñ0.09 V,	power-do	wn reset:	: 1.59 V ±	±0.09 V						Power-on reset: 1.61 V \pm 0.09 V, power-down reset: 1.59 V \pm 0.09 V P					Power-on reset: 1.61 V ±0	.09 V, power-down r	.eset: 1.59 V ±0.09 V				
Other peripheral	Other peripheral functions				ion, key interrupt	function						CAN co	ontroller,	data	flash men	nory: 16 K	B, key int	terrupt fu	unction							IO	Link tra	ansceiver		RF tr	ransceiv	er		
Operating temper	rature		_	40 to +8	5°C										-40 to	+85°C											-40 to	+85°C		-40	to +85°0	C		
Notes 1. Under d																					ed the IO													

2. 7 KB when the self programming function is used.
3. Three of these pins are connected to the IO-Link transceiver.

Remark The specifications of products still under development are subject to change without notice.

Notes 4. Two of the external interrupt sources are connected the IO-Link transceiver.

5. Four of these pins are connected to the RF transceiver.

16 - b i t A I I F I a s h 2 0 1 0. 1 2

Product specifications (4/4)

Commercial name	2	78K0R/IB3	3	78K0F	R/IC3	78K0R/ID3	78K0R/IE3	78K0R/LG3	78K0R/LH3			
Pin count		30-pin	38-pir	1 44-pin	48-pin	52-pin	64-pin	80-pin	100-pin	128-pin		
Product name				5 = 5			35 33	00 1 0 0 1 0 0 0 0 0 0 0 0 0 0 0 0 0 0	8 8 4 8 8 8 8 8 9 8 9 8 9 8 9 8 9 8 9 9 9 9			
		µPD78F1201 µPD78F1203	µPD78F12 ⁻	лРD78F121 µРD78F12 ⁻ uPD78F12 ⁻	µРD78F1213 µРD78F1214 µРD78F1215	µРD78F1223 µРD78F1224 µРD78F1225	µРD78F12S µРD78F12S	LPD78F150 LPD78F150 LPD78F150	LPD78F150 LPD78F150 LPD78F150	APD78F1506A APD78F1507A APD78F1508A		
Flash memory (by	rtes)	16 K 32 K	16 K 3	2 K 16 K 32	K 32 K 48 K 64 K	32 K 48 K 64 K	32 K 48 K 64 K	64 K 96 K 128 K	64 K 96 K 128 K	64 K 96 K 128 K		
RAM (bytes)		1 K 1.5 K	1 K 1	5 K 1 K 1.5	K 1.5 K 2 K 3 K ^{Note}	1 1.5 K 2 K 3 K ^{Note}	1.5 K 2 K 3 K ^{Note 1}	4 K 6 K 7 K	4 K 6 K 7 K	4 K 6 K 7 K		
External bus	External memory expansion space	-		-		-	-	_	_	_		
interface	Bus type	_		-		-	-	-	-	-		
	Address bus	-		-		-	-	-	-	-		
	Data bus	_		_		_	_	_	_	_		
Power supply	Normal operation mode				2.7 to 5.5 V				1.8 to 5.5 V			
voltage	Flash memory programming mode				2.7 to 5.5 V				1.8 to 5.5 V			
Minimum instruct	ion execution time				0.05 μs (20 MHz: V _{DD} = 2.7 to 5	5.5 V)		0.05 µs (2	20 MHz: V_{DD} = 2.7 to 5.5 V), 0.2 μ s (5 MHz: V_{DD} = 1	1.8 to 5.5 V)		
Clock	Main clock High-speed system clock				ic/crystal/external clock: 2 to 2				Ceramic/crystal/external clock: 2 to 20 MHz			
	High-speed internal oscillation clock				Iz ±1.8%, 40 MHz ^{Note 2} +2.9%/-4				1 MHz ±13%, 8 MHz ±2%, 20 MHz ±2.4% (target	t)		
	Subclock	_			Crystal: 32.768				Crystal: 32.768 kHz			
	Low-speed internal oscillation clock				30 kHz ±10% (for WDT)				30 kHz ±10% (for WDT)			
I/O ports	Total	23	31	37	41	45	55	51	67	83		
	CMOS I/O	21	27	33	34	38	48	46	60	76		
	CMOS input	2	4	4	4	4	4	4	4	4		
	CMOS output	_	_	_	1	1	1	1	1	1		
	N-ch open-drain	_	_	_	2	2	2	_	2	2		
Timer	16-bit timer Number of channels	12	12	12	12	12	12	12	12	12		
	Function				on/pulse interval measurement/pulse w		output/PWM output/3-phase sine-			e width measurement/one-shot pulse output/PWM		
					2-channel drive/full-bridge drive/real-tir	ne output/interrupt signal thinning	function/AD conversion trigger output		output	e waar measarementone shot paise outputt with		
	PWM			nax. 9 channels ma		9 channels max.	11 channels max.	5 channels max.	7 channels max.	10 channels max.		
	Watchdog timer (WDT)	1	1	1	1	1	1	1	1	1		
	Real-time counter (RTC)	_	1	1	1	1	1	1	1	1		
Serial interface	CSI: 2 channels, UART: 1 channel	_	_	_	_	_	_	_	_	1		
	CSI: 1 channel, UART: 1 channel	_	_	_	_	_	_	-	1	-		
	CSI: 2 channels, UART: 1 channel, simple I ² C: 2 channels	_	_	_	_	_	_	_	_	_		
	CSI: 1 channel, UART: 1 channel, simple I ² C: 1 channel	1	1	1	1	1	1	2	2	2		
	CSI: 2 channels, UART (supporting LIN ^{Note 3}): 1 channel	_	_	1	1	1	1	_	_	_		
	CSI: 1 channel, simple I ² C: 1 channel	_	_	-	-	_	-	-	_	-		
	CSI	_	_	_	_	_	_	_	_	_		
	UART: 1 channel, simple I ² C: 1 channel	_	_	-	-	_	-	-	_	_		
	UART (supporting LIN)	1 Note 3	1 Note 3	_	_	_	_	1	1	1		
	UART	_	_	_	_	_	_	-	-	-		
	Simple I ² C	-	_	_	-	-	-	-	_	-		
	I ² C	-	_	-	1	1	1	-	1	1		
LCD controller/dr	iver	-	_	-	-	-	-	Display method can be switche	ed between internal voltage boosting, capacitive division	on, and external resistive division.		
	Segment signal output	-	-	_	-	-	-	31 (27) ^{Note 4}	40 (36) ^{Note 4}	54 (50) ^{Note 4}		
	Common signal output	-	-	_	-	-	-	4 (8) ^{Note 4}	4 (8) ^{Note 4}	4 (8) ^{Note 4}		
A/D converter		10 bits × 6	10 bits ×	8 10 bits × 10	10 bits × 11	10 bits × 11	10 bits × 12	12 bits ^{Note 5} × 8	12 bits ^{Note 5} × 12	12 bits ^{Note 5} × 12		
D/A converter		-	-	-	-	-	-	12 bits × 2 ^{Note 6}	12 bits × 2 ^{Note 6}	12 bits × 2 ^{Note 6}		
DMA controller		2	2	2	2	2	2	2	2	2		
Interrupt	External	6	8	8	8	8	8	8	12	13		
	Internal	31	33	33	34	34	34	28	33	33		
On-chip debug (N	IINICUBE2)	Supported Supported										
Multiplier/divider		Multiplier/divider: 16 bits × 16 bits = 32 bits, 32 bits + 32 bits = 32 bits, remainder: 32 bits Multiplier/divider: 16 bits × 16 bits = 32 bits, 32 bits + 32 bits = 32 bits, remainder: 32 bits Multiplier/divider: 16 bits × 16 bits = 32 bits, 32 bits = 32 bits, remainder: 32 bits										
Low-voltage dete				2.84/2.9	19/3.15/3.30/3.45/3.61/3.76/3.9/ low-voltage detection for an ex	2/4.07/ 4.22 V ±0.1 V	n be performed	1.91/2.07 (initial value)/2.22/2.38/2.53/2.68/2	2.84/2.99/3.15/3.30/3.45/3.61/3.76/3.92/4.07/4.22 ction for an external input pin (EXLVI) can be perf	V ±0.1 V (selectable by software), low-voltage		
Power-on clear (F	POC)			Power-on res	et: 1.61 V ±0.09 V, power-dowr	reset: 1.59 V ±0.09 V		Power-o	on reset: 1.61 V ±0.09 V, power-down reset: 1.59	V ±0.09 V		
Other peripheral	functions			Comparator: 2 ch	annels, programmable gain am	plifier: 1 channel		Operational amplifier: 2 channels, key interrupt function	Operational amplifier: 3 channels, key interrupt function	Operational amplifier: 3 channels, key interrupt function		
Operating temper	rature				–40 to +85°C				−40 to +85°C			
	en the self programming function is used.						Notes 4 Values in perent	theses are the number of signal outputs when 8				

Notes 1. 2 KB when the self programming function is used.

mming function is used.

Notes 4. Values in parentheses are the number of signal outputs when 8com signal is used.

supplied to the timer array unit and the 20 MHz clock is supplied to the CPU and peripheral functions.

5. The A/D converter has 10-bit resolution in the μPD78F151xA.

The 40 MHz clock is only supplied to the timer array unit and the 20 MHz clock is supplied to the CPU and peripheral functions.
 3. 3-phase sine-wave PWM output/full-bridge drive is disabled when LIN is used. Half-bridge drive is also restricted to 1 channel.

Not available in the μPD78F151xA.

35

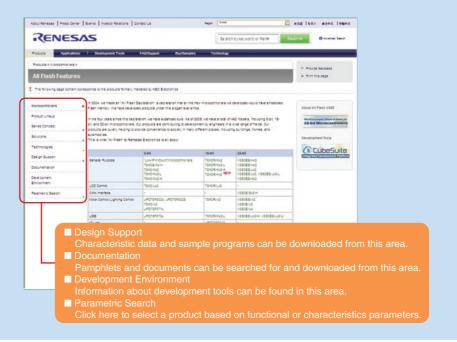
16 - b i t A I I F I a s h 2 0 1 0. 1 2

MEMO	MEMO
	-

MEMO

The Microcontrollers page on the Renesas Electronics website provides a range of information, including All Flash documentation and other contents.

http://www2.renesas.com/micro/en/promotion/allflash/



See our website for a comprehensive list of partner companies providing products for Renesas Electronics All Flash microcontrollers.

http://www.renesas.com/products/tools/partner_information/partners_landing.jsp



Caution This product uses SuperFlash® under license from Silicon Storage Technology, Inc.

Applilet is a registered trademark of Renesas Electronics Corporation in Japan, Germany, Hong Kong, China, the Republic of Korea, the United Kingdom, and the United States of America.

IECUBE is a registered trademark of Renesas Electronics Corporation in Japan and Germany.

CubeSuite and EEPROM are trademarks of Renesas Electronics Corporation.

HDMI is either a registered trademark or trademark of HDMI Licensing, LLC. in the United States and/or other countries. SuperFlash is a registered trademark of Silicon Storage Technology, Inc. in several countries including the United States and Japan.

TMDS is either a registered trademark or trademark of Silicon Image, Inc. in the United States and/or other countries.

Windows is either a registered trademark or trademark of Microsoft Corporation in the United States and/or other countries.

ZigBee is a registered trademark of ZigBee Alliance in several countries including the United States and Japan.

The names of other companies and products are the registered trademarks or trademarks of their companies.

38 39

Renesas Electronics Corporation

- All information included in this document is current as of the date this document is issued. Such information, however, is subject to change without any prior notice. Before purchasing or using any Renesas Electronics products listed herein, please confirm the latest product information with a Renesas Electronics sales office. Also, please pay regular and careful attention to additional and different information to be disclosed by Renesas Electronics such as that disclosed through our website.

 Renesas Electronics does not assume any liability for infringement of patents, copyrights, or other intellectual property rights of third parties by or arising from the use of Renesas Electronics products or technical information described in this document. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or
- You should not alter, modify, copy, or otherwise misappropriate any Renesas Electronics product, whether in whole or in part
- Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation of these circuits, software, and information in the design of your equipment. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from the

- You should not alter, modily, copy, or otherwise misappropriate any Renesas Electronics product, whether in whole or in part.

 Descriptions of circuits, software, and information in the design of your equipment. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from the use of these circuits, software, or information.

 When exporting the products or technology described in this document, you should not use of these circuits, software, or information.

 When exporting the products or technology described in this document, you should not use Renesas Electronics products or the technology described in this document for any purpose relating to military applications or use by the military, including but not limited to the development of weapons of mass destruction. Renesas Electronics products and technology may not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreass Electronics products and technology may not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreass Electronics products and the products are disabled domestic or foreass Electronics products and sales incurred by you resulting from errors in or omissions from the information included herein.

 Renesas Electronics products are disabled according to the following three quality grades: "Slandard". "Inigia Quality", and "Specific". The recommended applications for each Renesas Electronics product are disabled according to the following three quality grades." Slandard". "Inigia Quality", and "Specific". The recommended applications of the product is an admissible according to the lollowing three quality grades." Slandard "Inigia Quality", and "Specific". The results of the product is an admissible according to the lollowing three quality grades." Slandard "Inigia Quality", and "Specific". The results of the product of any applicati



SALES OFFICES

http://www.renesas.com

Refer to "http://www.renesas.com/" for the latest and detailed information.

Renesas Electronics America Inc. 2880 Scott Boulevard Santa Clara, CA 95050-2554, U.S.A. Tel: +1-408-588-6000, Fax: +1-408-588-6130

Renesas Electronics Canada Limited

1101 Nicholson Road, Newmarket, Ontario L3Y 9C3, Canada Tel: +1-905-898-5441, Fax: +1-905-898-3220

Renesas Electronics Europe Limited

Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K Tel: +44-1628-585-100, Fax: +44-1628-585-900

Renesas Electronics Europe GmbH

Arcadiastrasse 10, 40472 Düsseldorf, Germany Tel: +49-211-65030, Fax: +49-211-6503-1327

Renesas Electronics (China) Co., Ltd.
7th Floor, Quantum Plaza, No.27 ZhiChunLu Haidian District, Beijing 100083, P.R.China Tel: +86-10-8235-1155, Fax: +86-10-8235-7679

Renesas Electronics (Shanghai) Co., Ltd.

Unit 204, 205, AZIA Center, No.1233 Lujiazui Ring Rd., Pudong District, Shanghai 200120, China Tel: +86-21-5877-1818, Fax: +86-21-6887-7858 / -7898

Renesas Electronics Hong Kong Limited
Unit 1601-1613, 16/F., Tower 2, Grand Century Place, 193 Prince Edward Road West, Mongkok, Kowloon, Hong Kong Tel: +852-2886-9318, Fax: +852 2886-9022/9044

Renesas Electronics Taiwan Co., Ltd. 7F, No. 363 Fu Shing North Road Taipei, Taiwan Tel: +886-2-8175-9600, Fax: +886 2-8175-9670

Renesas Electronics Singapore Pte. Ltd.
1 harbourFront Avenue, #06-10, keppel Bay Tower, Singapore 098632 Tel: +65-6213-0200, Fax: +65-6278-8001

Renesas Electronics Malaysia Sdn.Bhd.

Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No. 18, Jln Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia Tel: +60-3-7955-9390, Fax: +60-3-7955-9510

Renesas Electronics Korea Co., Ltd.

11F., Samik Lavied' or Bldg., 720-2 Yeoksam-Dong, Kangnam-Ku, Seoul 135-080, Korea Tel: +82-2-558-3737, Fax: +82-2-558-5141

